



## Device Pin Assignment

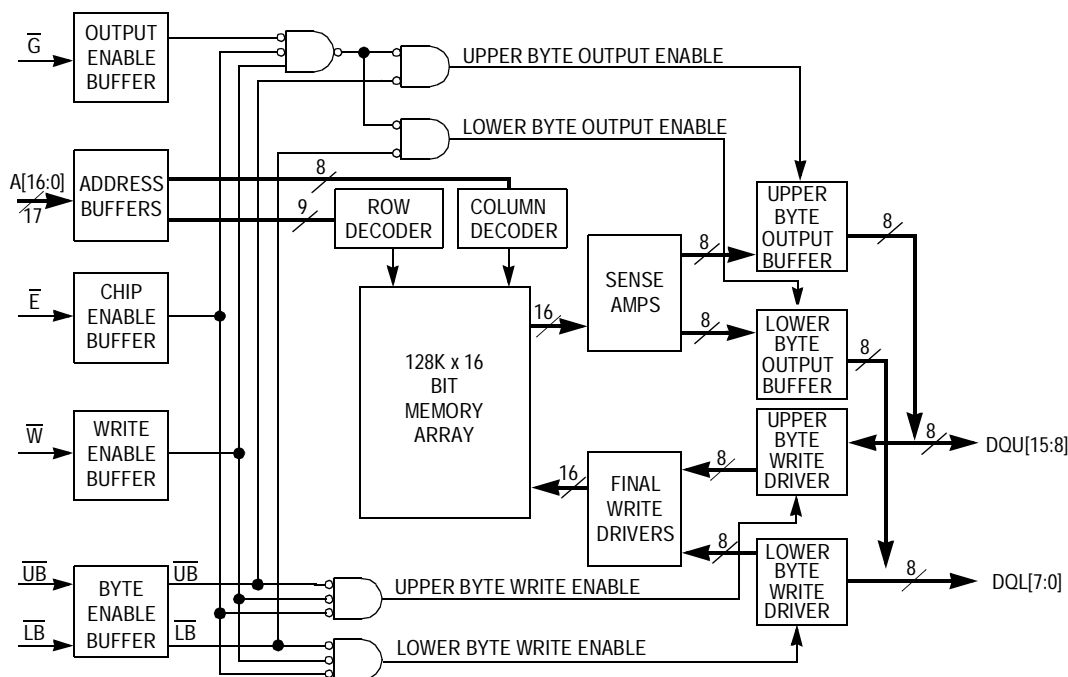


Figure 1. Block Diagram

## Device Pin Assignment

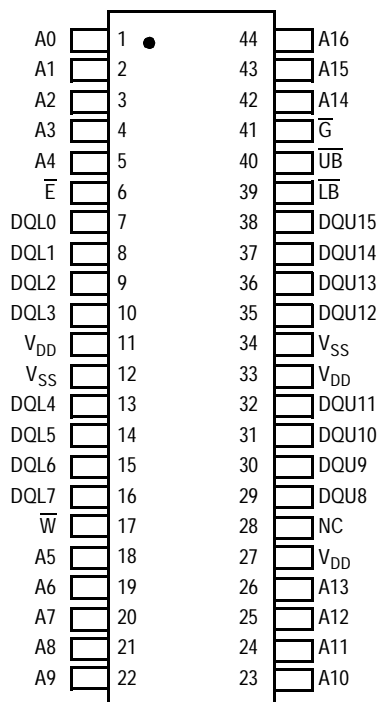


Table 1. Pin Functions

Signal Name	Function
A	Address input
$\bar{E}$	Chip enable
$\bar{W}$	Write enable
$\bar{G}$	Output enable
$\bar{UB}$	Upper byte select
$\bar{LB}$	Lower byte select
DQL	Data I/O, lower byte
DQU	Data I/O, upper byte
$V_{DD}$	Power supply
$V_{SS}$	Ground
NC	Do not connect this pin

Figure 2. MR1A16A in 44-Pin TSOP Type II Package





## Direct Current (dc)

Table 5. dc Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Input leakage current	$I_{lkg(I)}$	—	—	$\pm 1$	$\mu\text{A}$
Output leakage current	$I_{lkg(O)}$	—	—	$\pm 1$	$\mu\text{A}$
Output low voltage ( $I_{OL} = +4 \text{ mA}$ ) ( $I_{OL} = +100 \mu\text{A}$ )	$V_{OL}$	—	—	$0.4$ $V_{SS} + 0.2$	V
Output high voltage ( $I_{OH} = -4 \text{ mA}$ ) ( $I_{OH} = -100 \text{ mA}$ )	$V_{OH}$	$2.4$ $V_{DD} - 0.2$	—	—	V

Table 6. Power Supply Characteristics

Parameter	Symbol	Typ	Max	Unit
ac active supply current — read modes <sup>1</sup> ( $I_{Out} = 0 \text{ mA}$ , $V_{DD} = \text{max}$ )	$I_{DDR}$	55	80	mA
ac active supply current — write modes <sup>1</sup> ( $V_{DD} = \text{max}$ ) MR1A16AYS35 (Commercial) MR1A16ACYS35 (Industrial) MR1A16AVYS35 (Extended)	$I_{DDW}$	105 105 105	155 165 165	mA
ac standby current ( $V_{DD} = \text{max}$ , $\bar{E} = V_{IH}$ ) (no other restrictions on other inputs)	$I_{SB1}$	18	28	mA
CMOS standby current ( $\bar{E} \geq V_{DD} - 0.2 \text{ V}$ and $V_{In} \leq V_{SS} + 0.2 \text{ V}$ or $\geq V_{DD} - 0.2 \text{ V}$ ) ( $V_{DD} = \text{max}$ , $f = 0 \text{ MHz}$ )	$I_{SB2}$	9	12	mA

NOTES:

<sup>1</sup> All active current measurements are measured with one address transition per cycle.

 Table 7. Capacitance<sup>1</sup>

Parameter	Symbol	Typ	Max	Unit
Address input capacitance	$C_{In}$	—	6	pF
Control input capacitance	$C_{In}$	—	6	pF
Input/output capacitance	$C_{I/O}$	—	8	pF

NOTES:

<sup>1</sup>  $f = 1.0 \text{ MHz}$ ,  $dV = 3.0 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ , periodically sampled rather than 100% tested.

Table 8. ac Measurement Conditions

Parameter	Value
Logic input timing measurement reference level	1.5 V
Logic output timing measurement reference level	1.5 V
Logic input pulse levels	0 or 3.0 V
Input rise/fall time	2 ns
Output load for low and high impedance parameters	See Figure 3A
Output load for all other timing parameters	See Figure 3B

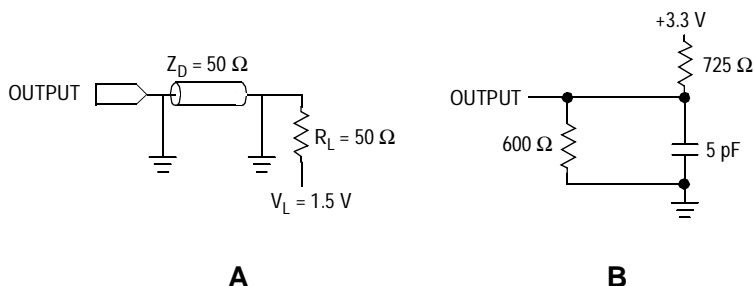


Figure 3. Output Load for ac Test









## Write Mode

**Table 10. Write Cycle Timing 1 ( $\overline{W}$  Controlled)<sup>1, 2, 3, 4, 5</sup>**

Parameter	Symbol	Min	Max	Unit
Write cycle time <sup>6</sup>	$t_{AVAV}$	35	—	ns
Address set-up time	$t_{AVWL}$	0	—	ns
Address valid to end of write ( $\overline{G}$ high)	$t_{AVWH}$	18	—	ns
Address valid to end of write ( $\overline{G}$ low)	$t_{AVWH}$	20	—	ns
Write pulse width ( $\overline{G}$ high)	$t_{WLWH}$ $t_{WLEH}$	15	—	ns
Write pulse width ( $\overline{G}$ low)	$t_{WLWH}$ $t_{WLEH}$	15	—	ns
Data valid to end of write	$t_{DVWH}$	10	—	ns
Data hold time	$t_{WHDX}$	0	—	ns
Write low to data Hi-Z <sup>7, 8, 9</sup>	$t_{WLQZ}$	0	12	ns
Write high to output active <sup>7, 8, 9</sup>	$t_{WHQX}$	3	—	ns
Write recovery time	$t_{WHAX}$	12	—	ns

## NOTES:

- <sup>1</sup> A write occurs during the overlap of  $\overline{E}$  low and  $\overline{W}$  low.
- <sup>2</sup> Due to product sensitivities to noise, power supplies must be properly grounded and decoupled and bus contention conditions must be minimized or eliminated during read and write cycles.
- <sup>3</sup> If  $\overline{G}$  goes low at the same time or after  $\overline{W}$  goes low, the output will remain in a high-impedance state.
- <sup>4</sup> After  $\overline{W}$ ,  $\overline{E}$ , or  $\overline{UB/LB}$  has been brought high, the signal must remain in steady-state high for a minimum of 2 ns.
- <sup>5</sup> The minimum time between  $\overline{E}$  being asserted low in one cycle to  $\overline{E}$  being asserted low in a subsequent cycle is the same as the minimum cycle time allowed for the device.
- <sup>6</sup> All write cycle timings are referenced from the last valid address to the first transition address.
- <sup>7</sup> This parameter is sampled and not 100% tested.
- <sup>8</sup> Transition is measured  $\pm 200$  mV from steady-state voltage.
- <sup>9</sup> At any given voltage or temperature,  $t_{WLQZ}$  max <  $t_{WHQX}$  min.

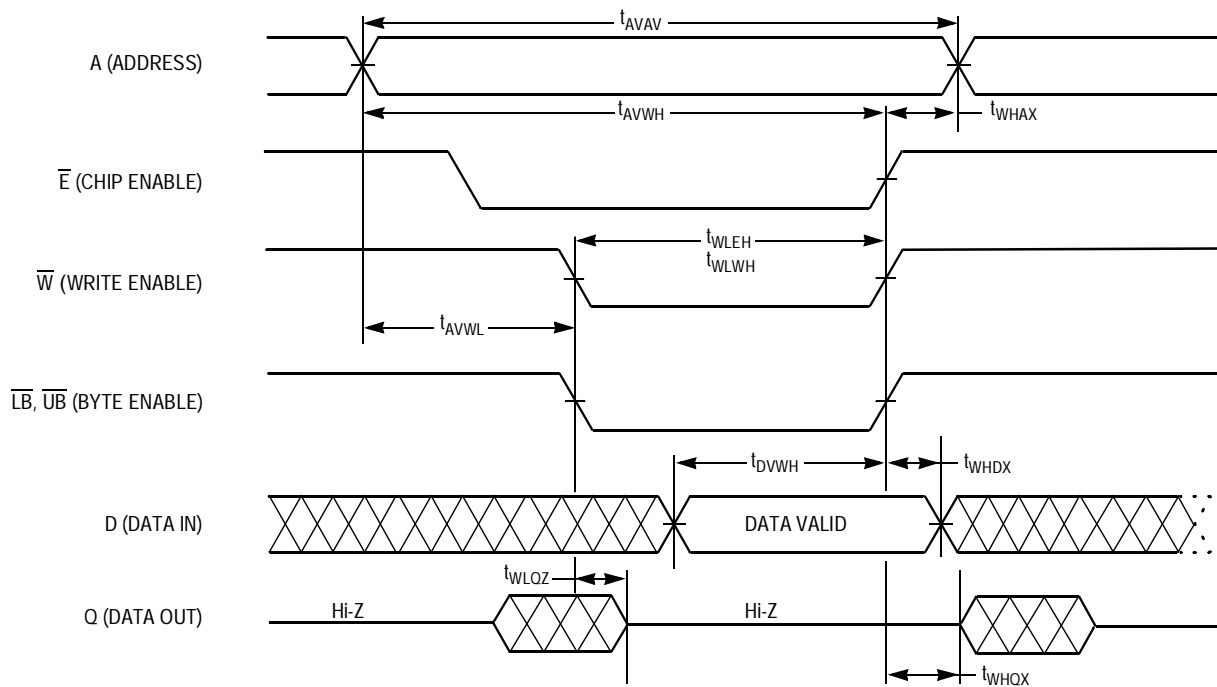


Figure 6. Write Cycle 1 ( $\bar{W}$  Controlled)



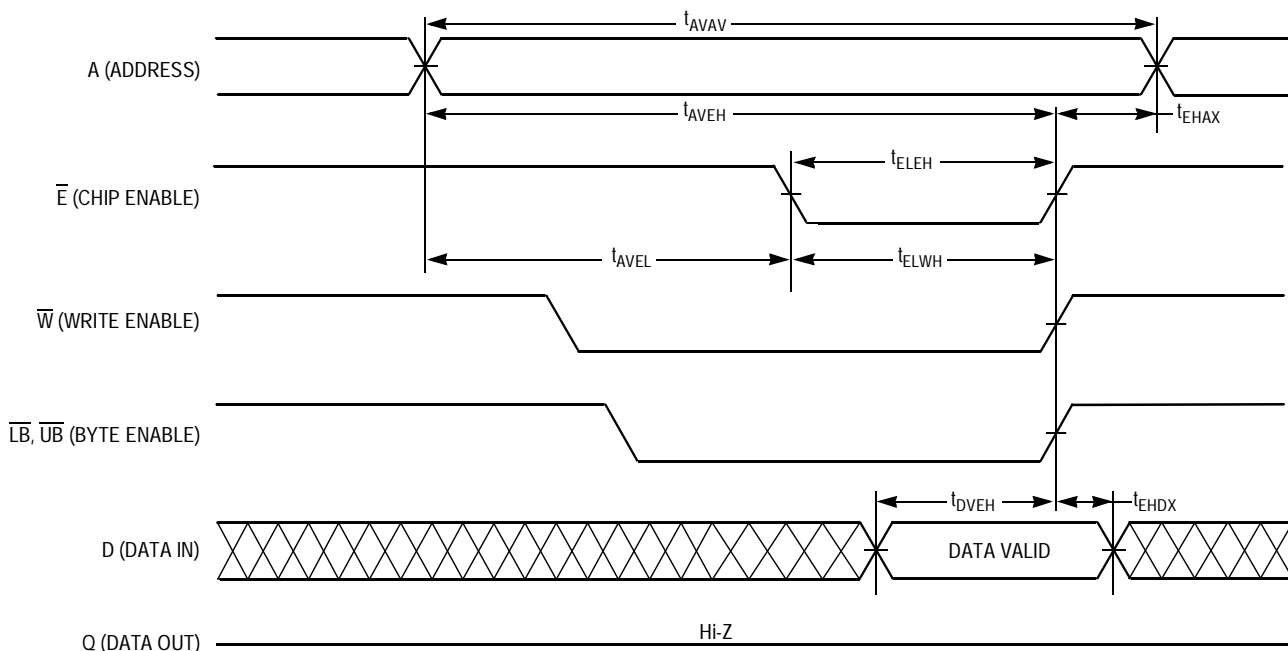


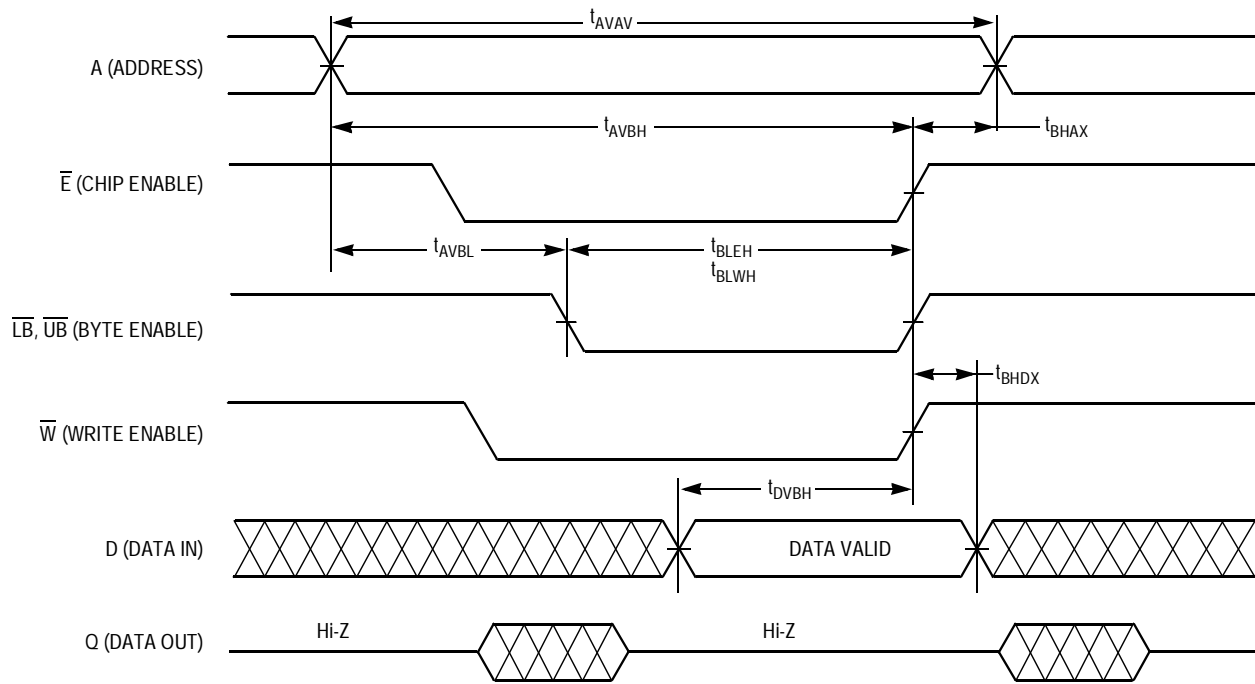
Figure 7. Write Cycle 2 ( $\bar{E}$  Controlled)

**Table 12. Write Cycle Timing 3 ( $\overline{\text{LB}}/\overline{\text{UB}}$  Controlled)<sup>1, 2, 3, 4, 5, 6</sup>**

Parameter	Symbol	Min	Max	Unit
Write cycle time <sup>7</sup>	$t_{\text{AVAV}}$	35	—	ns
Address set-up time	$t_{\text{AVBL}}$	0	—	ns
Address valid to end of write ( $\overline{\text{G}}$ high)	$t_{\text{AVBH}}$	18	—	ns
Address valid to end of write ( $\overline{\text{G}}$ low)	$t_{\text{AVBH}}$	20	—	ns
Byte pulse width ( $\overline{\text{G}}$ high)	$t_{\text{BLEH}}$ $t_{\text{BLWH}}$	15	—	ns
Byte pulse width ( $\overline{\text{G}}$ low)	$t_{\text{BLEH}}$ $t_{\text{BLWH}}$	15	—	ns
Data valid to end of write	$t_{\text{DVBH}}$	10	—	ns
Data hold time	$t_{\text{BHDX}}$	0	—	ns
Write recovery time	$t_{\text{BHAX}}$	12	—	ns

**NOTES:**

- <sup>1</sup> A write occurs during the overlap of  $\overline{\text{E}}$  low and  $\overline{\text{W}}$  low.
- <sup>2</sup> Due to product sensitivities to noise, power supplies must be properly grounded and decoupled and bus contention conditions must be minimized or eliminated during read and write cycles.
- <sup>3</sup> If  $\overline{\text{G}}$  goes low at the same time or after  $\overline{\text{W}}$  goes low, the output will remain in a high-impedance state.
- <sup>4</sup> After  $\overline{\text{W}}$ ,  $\overline{\text{E}}$ , or  $\overline{\text{UB}}/\overline{\text{LB}}$  has been brought high, the signal must remain in steady-state high for a minimum of 2 ns.
- <sup>5</sup> If both byte control signals are asserted, the two signals must have no more than 2 ns skew between them.
- <sup>6</sup> The minimum time between  $\overline{\text{E}}$  being asserted low in one cycle to  $\overline{\text{E}}$  being asserted low in a subsequent cycle is the same as the minimum cycle time allowed for the device.
- <sup>7</sup> All write cycle timings are referenced from the last valid address to the first transition address.



**Figure 8. Write Cycle 3 ( $\overline{LB}/\overline{UB}$  Controlled)**

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**Ordering Information**

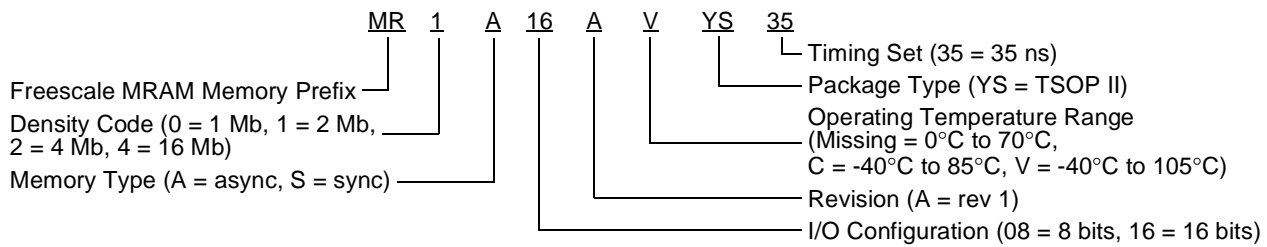
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**Part Numbering System**

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**Package Information**

**Table 13. Package Information**

Device	Pin Count	Package Type	Designator	Case No.	Document No.	RoHS Compliant
MR1A16A	44	TSOP Type II	YS	924A-02	98ASS23673W	True



## Revision History

### Revision History

Rev	Date	Description of Change
1	10 Aug 2007	Initial public release version.
2	21 Sep 2007	Table 6: Applied values to TBD's in IDD specifications.
3	12 Nov 2007	Table 2: Changed IDDA to IDDR or IDDW.

## Mechanical Drawing

The following pages detail the package available to MR1A16A.









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